

3.5 x 2.8 mm SMD CHIP LED LAMP

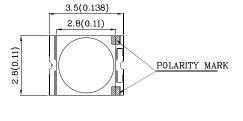
#### **Features**

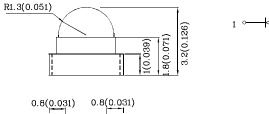
- Ideal for indication light on hand held products
- Long life and robust package
- Standard Package: 500pcs/ Reel
- $\bullet$  MSL (Moisture Sensitivity Level): 3
- RoHS compliant

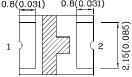




## Package Schematics







#### Notes

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.2(0.008")$  unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T <sub>A</sub> =25°C)	M2CRK (AlGaInP)	Unit		
Reverse Voltage	$V_{\rm R}$	5	V	
Forward Current	$I_{\mathrm{F}}$	30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	150	mA	
Power Dissipation	$P_{D}$	84	mW	
Operating Temperature	$T_{\rm A}$	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +85		

Operating Characteristics (T <sub>A</sub> =25°C)	M2CRK (AlGaInP)	Unit	
Forward Voltage (Typ.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	2.2	V
Forward Voltage (Max.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	2.8	V
Reverse Current (Max.) (V <sub>R</sub> =5V)	$I_R$	10	uA
Wavelength of Peak Emission CIE127-2007* (Typ.) (I <sub>F</sub> =20mA)	λP	640*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) $(I_F=20\text{mA})$	λD	625*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =20mA)	Δλ	20	nm
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	С	27	pF

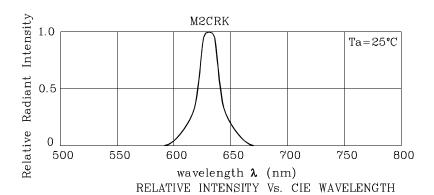
Part Numbe	Emitt Colo	0	Lens-color	$\begin{array}{c} \text{Luminous Intensity} \\ \text{CIE127-2007*} \\ \text{(I_F=20mA)} \\ \text{mcd} \end{array}$	Wavelength CIE127-2007* nm λP	Viewing Angle 20 1/2

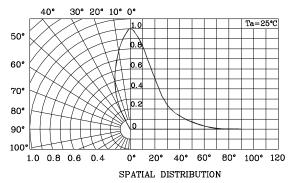
				min.	typ.		
XZM2CRK45W-2	Red	AlGaInP	Water Clear	3100 1000*	3790 1790*	640*	40°

 $<sup>*</sup>Luminous\ intensity\ value\ and\ wavelength\ are\ in\ accordance\ with\ CIE127-2007\ standards.$ 

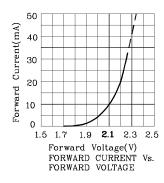


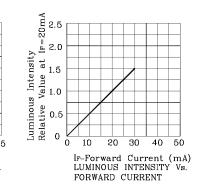


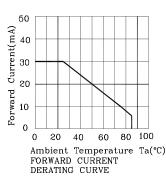


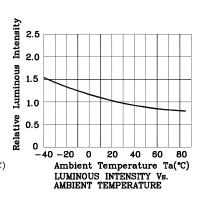


#### **❖** M2CRK



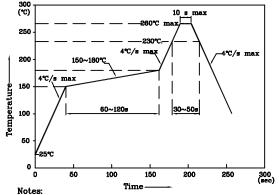






# LED is recommended for reflow soldering and soldering profile is shown below.

#### Reflow Soldering Profile for SMD Products (Pb-Free Components)

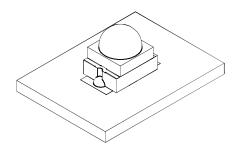


- 1. Maximum soldering temperature should not exceed 260°C
- 2. Recommended reflow temperature: 145°C-260°C
- 3. Do not put stress to the epoxy resin during high temperatures conditions

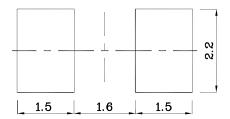




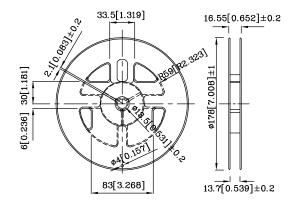
❖ The device has a single mounting surface. The device must be mounted according to the specifications.



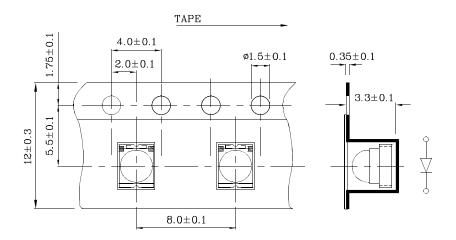
**♦** Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



#### \* Reel Dimension



### ❖ Tape Specification (Units:mm)



### Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

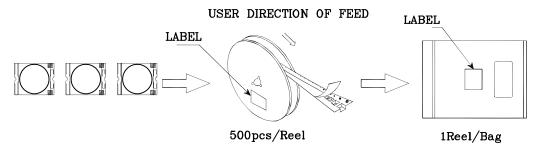
- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

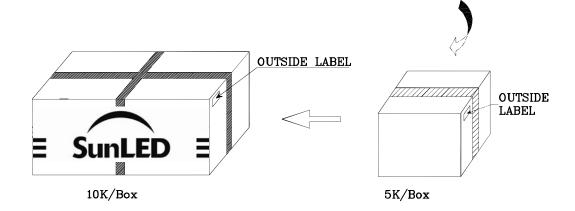
Note: Accuracy may depend on the sorting parameters.

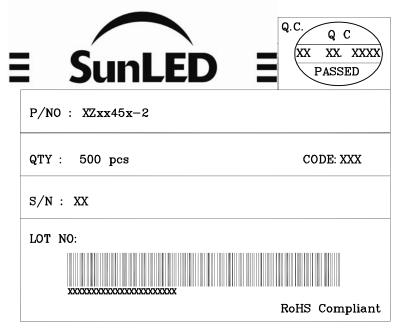




#### PACKING & LABEL SPECIFICATIONS







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